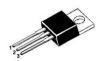


ULTRAFAST RECOVERY RECTIFIERS





TO-220AB/CT

TO-220F/FCT

TO-252/CS





TO-263/DC

10

TO-251/D

Primary Characteristic Io 20A V_{RRM} 200V I_{FSM} 200A V_F 0.83V T_Jmax 175 °C

FEATURES

- High speed switching capability
- High current capability
- High forward surge capability
- Low power losses, High efficiency
- High reliability
- For use in low voltage, high frequency inverters



APPLICATIONS

Fast recovery diode, mainly used for rectification, used in high-power equipment, The express and ultrafast recovery diodes are suitable for high frequency and ultra high frequency circuits, respectively

MECHANICAL DATA

Case: Molded plasticPolarity: As markedMounting Position: Any

Molded Plastic: UL Flammability Classification Rating 94V-0
 Lead free in compliance with EU RoHS 2011/65/EU directive

• Solder bath temperature 275°C maximum, 10s per JESD 22-B106

Maximum Ratings (Per Leg) at Ta=25°C unless otherwise specified				
Characteristics	Symbol	Value	Unit	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	V	
Working Peak Reverse Voltage	V_{RWM}	200	V	
Maximum DC Blocking Voltage	V_{DC}	200	V	
Maximum Average Forward Rectified	Io	20	Α	
Peak Forward Surge Current,8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	200	Α	
Operating Temperature Range	TJ	175	°C	
Storage Temperature Range	T _{STG}	-55 to +175	°C	
Typical Thermal Resistance (Note1)				
TO-220AB,TO-263	R _{0 JC}	2	°C/W	
TO-220F		4		

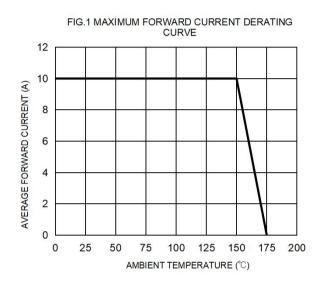
Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

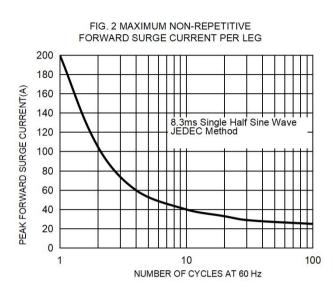
Electrical Characteristics (Per Leg) unless otherwise specified					
Characteristics		Symbol	Value		Unit
Forward Voltage Drop(Note2)			Тур.	Max.	
at I₅=5A	TA=25°C	V _F	0.81	-	
at I _F -5A	TA=125°C		0.66	-	V
-+1 404	TA=25°C		0.89	-	
at I _F =10A	TA=125°C		0.74	-	
ot 1 =20A	TA=25°C		0.98	1.05	
at I _F =20A	TA=125°C		0.83	-	
Maximum Reverse Current at V _R =200V	TA=25°C		2	-	μA
	TA=125°C	I _R	-	2	μΑ
Maximum Reverse Recovery Time at I _F =0.5A, I _R =1A,		Trr	19	-	ns

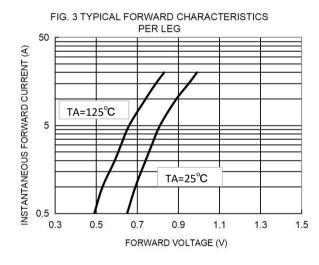
Note2:Pulse test: 300 µs pulse width, 1 % duty cycle

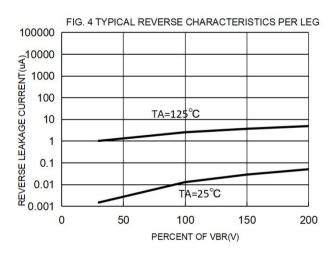


RATINGS AND CHARACTERISTIC CURVES



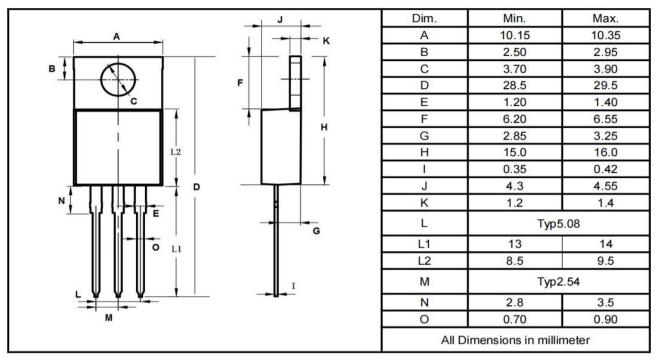




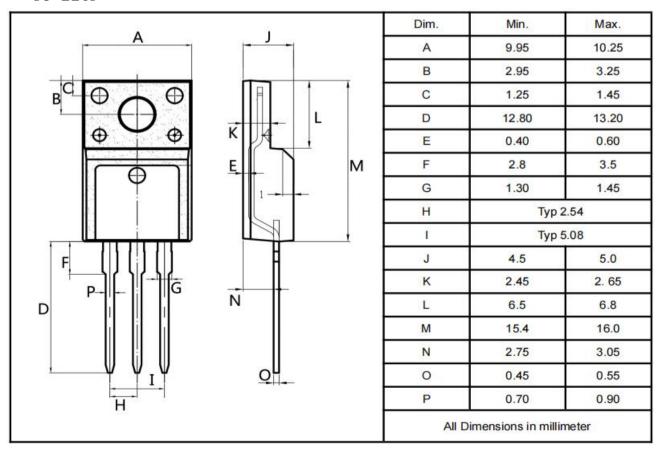


Package Outline Dimensions millimeters

TO-220AB

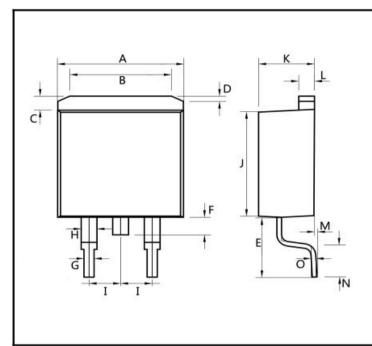


TO-220F



Package Outline Dimensions millimeters

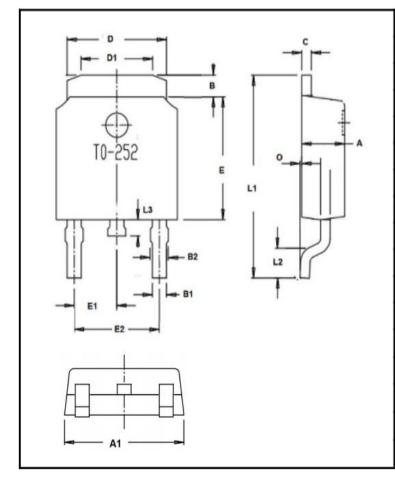
TO-263



Dim.	Min.	Max.	
Α	10.10	10.35	
В	6	8	
С	1.2	1.5	
D	0.55	1.0	
E	4.3	5.3	
F	1.4	1.6	
G	0.75	0.85	
Н	1.2	1.5	
I	Typ2.54		
J	8.5	9.5	
K	4.3	4.55	
L	1.25	1.35	
M	0.02	0.23	
N	2.2	2.8	
0	0.3	0.4	

All Dimensions in millimeter

TO-252

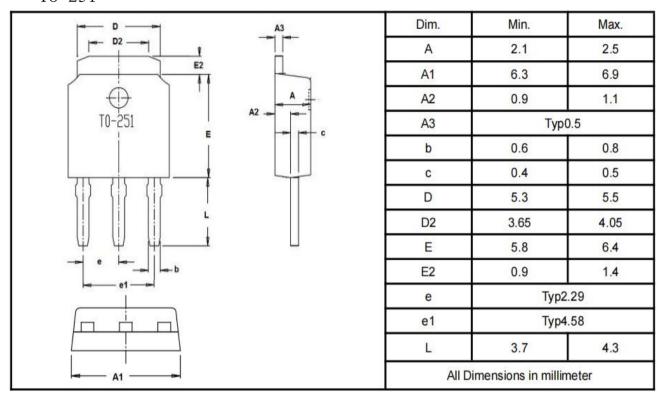


Dim.	Min.	Max.	
Α	2.1	2.5	
A1	6.3	6.9	
В	0.95	1.55	
B1	0.6	0.8	
B2	0.75	0.95	
С	Typ0.5		
D	5.3	5.5	
D1	3.65	4.05	
E	5.8	6.4	
E1	Typ2.3		
E2	Typ4.6		
0	0	0.15	
L1	9	11	
L2	Typ1.5		
L3	0.7 1.0		
All Dimensions in millimeter			

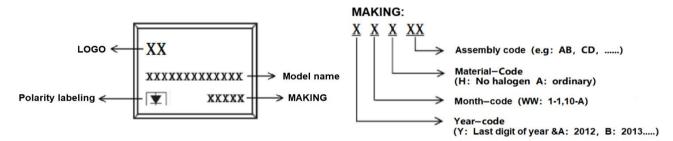


Package Outline Dimensions millimeters

TO-251



Marking on the body



Ordering information				
Part Number	Package	Unit Weight	Base Quantity	Delivery mode
MUR2020SCT	TO-220AB	0.07oz(1.96g)	50 pcs / tube	1000pcs/box 5000pcs/carton
MUR2020SFCT	TO-220F	0.06oz(1.74g)	50 pcs / tube	1000pcs/box 5000pcs/carton
MUR2020SDC	TO-263	0.04oz(1.16g)	50 pcs / tube	1000pcs/box 5000pcs/carton
MUR2020SDC-R	TO-263	0.04oz(1.16g)	800 pcs / reel	1600pcs/box 8000pcs/carton
MUR2020SCS	TO-252	0.011oz(0.32g)	2500 pcs / reel	5000pcs/box 25000pcs/carton
MUR2020SD	TO-251	0.011oz(0.32g)	80 pcs / tube	4000pcs/box 24000pcs/carton

Note: For Halogen Free molding compound, add "H" suffix to part number above.



packing instruction

PKG	最小包装	内盒	外箱	
TO-220AB TO-220F TO-263			898 898 898 898	
	50pcs/管	1000pcs/盒	5000pcs/箱	
TO-263-R	TO-263-R			
	800pcs/盘	1600pcs/盒	8000pcs/箱	
TO-252				
	2500pcs/盘	5000pcs/盘	25000pcs/箱	
TO-251				
	80pcs/管	4000pcs/盒	24000pvs/箱	

Notice

- 1. All product, product specifications and data are subject to change without notice to improve. The right to explain is owned by LINGXUN electronics company.
- 2. Confirm that operation temperature is within the specified range described in the product specification. Avoid applying power exceeding normal rated power;

exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

3. LINGXUN electronics shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.